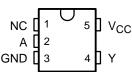
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- Operating Range 2-V to 5.5-V V_{CC}
- Unbuffered Output
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DBV OR DCK PACKAGE (TOP VIEW)



NC - No internal connection

description/ordering information

The SN74AHC1GU04 contains a single inverter gate. The device performs the Boolean function $Y = \overline{A}$. Internal circuitry consists of a single-stage inverter that can be used in analog applications, such as crystal oscillators.

ORDERING INFORMATION

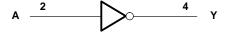
TA	PACKAGE	<u>:</u> †	ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
	COT (COT 22) DDV	Reel of 3000	SN74AHC1GU04DBVR	0114
4000 1- 0500	SOT (SOT-23) – DBV	Reel of 250	SN74AHC1GU04DBVT	AU4_
–40°C to 85°C	COT (CC 70) DCV	Reel of 3000	SN74AHC1GU04DCKR	AD
	SOT (SC-70) – DCK	Reel of 250	SN74AHC1GU04DCKT	AD_

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

INPUT A	OUTPUT Y
Н	L
L	Н

logic diagram (positive logic)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡] The actual top-side marking has one additional character that designates the assembly/test site.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	0.5 V to 7 V
Output voltage range, V _O (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ _{JA} (see Note 2): DBV package	206°C/W
DCK package	252°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	V
		V _{CC} = 2 V	1.7		
V_{IH}	High-level input voltage	V _{CC} = 3 V	2.4		V
		V _{CC} = 5.5 V	4.4		
		V _{CC} = 2 V		0.3	
V _{IL}	Low-level input voltage	V _{CC} = 3 V		0.6	6 V
		V _{CC} = 5.5 V		1.1	
٧ _I	Input voltage		0	5.5	V
٧o	Output voltage		0	VCC	V
		V _{CC} = 2 V		-50	μΑ
loh	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	
		$V_{CC} = 5 V \pm 0.5 V$		-8	mA
		V _{CC} = 2 V		50	μΑ
lOL	Low-level output current	V _{CC} = 3.3 V ± 0.3 V		4	
		$V_{CC} = 5 V \pm 0.5 V$		8	mA
T _A	Operating free-air temperature		-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

BABAMETED	TOT COUNTIONS	V CC 2 V	T,	λ = 25°C	;	MIN	MAX	
PARAMETER	TEST CONDITIONS		MIN	TYP	MAX			UNIT
		2 V	1.8	2		1.8		
	I _{OH} = -50 μA	3 V	2.7	3		2.7		
Voн		4.5 V	4	4.5		4		V
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		
	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		
		2 V			0.2		0.2	
	I _{OL} = 50 μA	3 V			0.3		0.3	
VOL		4.5 V			0.5		0.5	V
	I _{OL} = 4 mA	3 V			0.36		0.44	
	I _{OL} = 8 mA	4.5 V			0.36		0.44	
lį	V _I = 5.5 V or GND	0 V to 5.5 V			±0.1		±1	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μΑ
C _i	$V_I = V_{CC}$ or GND	5 V		2	10		10	pF

switching characteristics over recommended operating free-air temperature range, $V_{CC}=$ 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	OUTPUT	T,	չ = 25°C	;	14151	MAX			
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN		UNIT		
^t PLH		V	0 45 5		5	7.1	1	8.5			
^t PHL	А	Y	C _L = 15 pF		5	7.1	1	8.5	ns		
^t PLH	^	V	C: _ 50 pF		7.5	10.6	1	12	20		
t _{PHL}	А	ſ	C _L = 50 pF		7.5	10.6	1	12	ns		

switching characteristics over recommended operating free-air temperature range, $V_{CC}=5~V\pm0.5~V$ (unless otherwise noted) (see Figure 1)

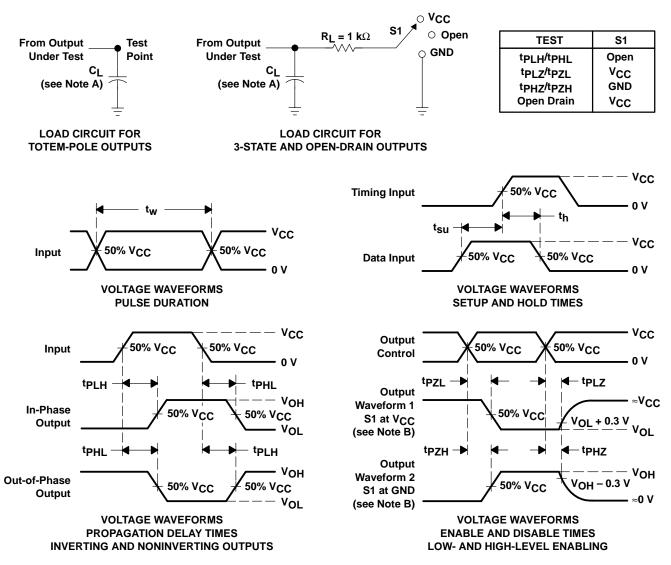
DADAMETED	FROM	то	OUTPUT	T,	∆ = 25°C		84181	BA A V	14 A V		
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT ns		
t _{PLH}		v	0. 45 = 5		3.5	5.5	1	6			
^t PHL	А	Y	C _L = 15 pF		3.5	5.5	1	6	ns		
t _{PLH}	^	V	C: _ 50 pF		5	7	1	8	20		
^t PHL	A	Y	Y	C _L = 50 pF		5	7	1	8	ns	

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CO	ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	7.3	pF



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

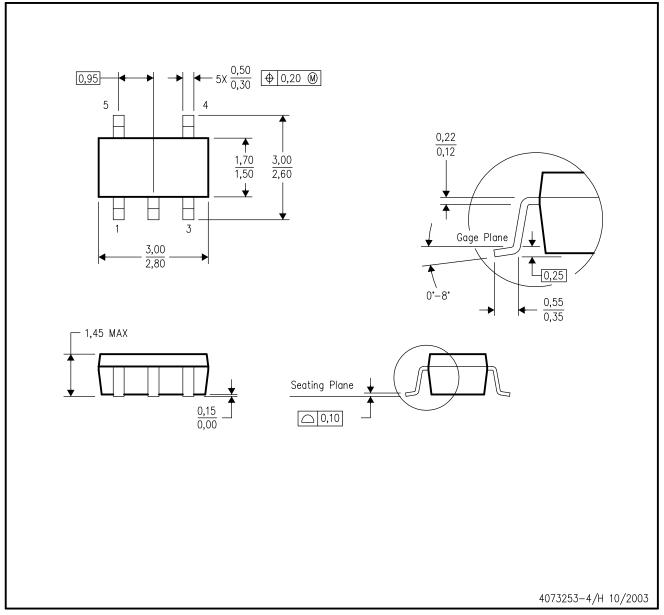
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



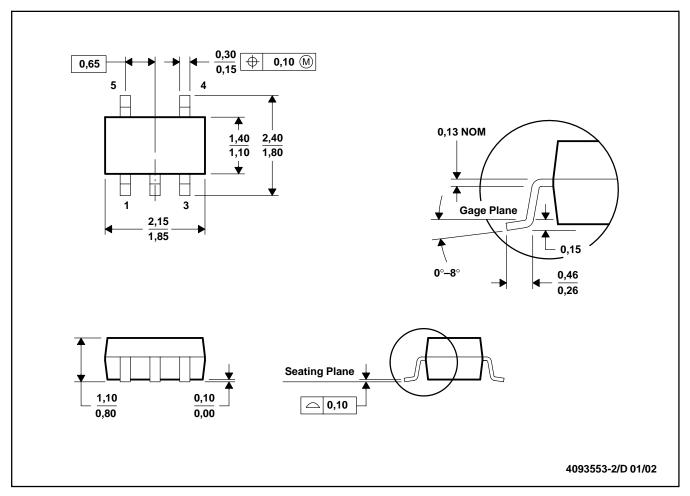
NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- C. Body dimensions do not include mold fla D. Falls within JEDEC MO—178 Variation AA. Body dimensions do not include mold flash or protrusion.



DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

D. Falls within JEDEC MO-203

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